

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6543054

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MIN WANG	11/30/2020
MANGESH CHANSARKAR	02/08/2021
NING LUO	12/01/2020
GENGSHENG ZHANG	12/01/2020
DAVID TUCK	11/30/2020
BO ZHENG	12/01/2020
YINGHUA YANG	12/01/2020
HAN ZHANG	12/01/2020
RECEIVING PARTY DATA	
Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16998612
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	lbreeden@wavsip.com
Correspondent Name:	WEAVER AUSTIN VILLENEUVE & SAMPSON LLP
Address Line 1:	P.O. BOX 70250
Address Line 4:	OAKLAND, CALIFORNIA 94612-0250
ATTORNEY DOCKET NUMBER:	QLCMP096US/193476
NAME OF SUBMITTER:	LELIA BREEDEN
SIGNATURE:	/Lelia Breedon/
DATE SIGNED:	02/09/2021

Total Attachments: 24

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ASSIGNMENT

WHEREAS, WE,

1. Min WANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
2. Mangesh CHANSARKAR, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
3. Ning LUO, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
4. Gengsheng ZHANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
5. David TUCK, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
6. Bo ZHENG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
7. Yinghua YANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
8. Han ZHANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **ULTRA-LONG BASELINE RTK** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at **5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.**, desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have

been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/998,612 filed August 20, 2020, Qualcomm Reference Number 193476, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Tustin, CA, on 11/30/2020
City, State Date


Min WANG

Done at _____, on _____
City, State Date

Mangesh CHANSARKAR

Done at _____, on _____
City, State Date

Ning LUO

Done at _____, on _____
City, State Date

Gengsheng ZHANG

Done at _____, on _____
City, State Date

David TUCK

Done at _____, on _____
City, State Date

Bo ZHENG

Done at _____, on _____
City, State Date

Yinghua YANG

Done at _____, on _____
City, State Date

Han ZHANG

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8. Han ZHANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714,**

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WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/998,612 filed August 20, 2020, Qualcomm Reference Number 193476, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State Date Min WANG

Done at Irvine, CA, on 02/08/2021
City, State Date M M Chansarkar
Mangesh CHANSARKAR

Done at _____, on _____
City, State Date Ning LUO

Done at _____, on _____
City, State Date Gengsheng ZHANG

Done at _____, on _____
City, State Date David TUCK

Done at _____, on _____
City, State Date Bo ZHENG

Done at _____, on _____
City, State Date Yinghua YANG

Done at _____, on _____
City, State Date Han ZHANG

ASSIGNMENT

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.


Done at _____, on _____
City, State Date

Min WANG

Done at _____, on _____
City, State Date

Mangesh CHANSARKAR

Done at Cupertino, CA, on 12/1/2020
City, State Date


Ning LUO

Done at _____, on _____
City, State Date

Gengsheng ZHANG

Done at _____, on _____
City, State Date

David TUCK

Done at _____, on _____
City, State Date

Bo ZHENG

Done at _____, on _____
City, State Date

Yinghua YANG

Done at _____, on _____
City, State Date

Han ZHANG

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Done at _____, on _____
City, State Date Min WANG

Done at _____, on _____
City, State Date Mangesh CHANSARKAR

Done at _____, on _____
City, State Date Ning LUO

Done at Cupertino, CA, on 12/01/2020
City, State Date Gengsheng ZHANG
Gengsheng ZHANG

Done at _____, on _____
City, State Date David TUCK

Done at _____, on _____
City, State Date Bo ZHENG

Done at _____, on _____
City, State Date Yinghua YANG

Done at _____, on _____
City, State Date Han ZHANG

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City, State Date Ning LUO

Done at _____, on _____
City, State Date Gengsheng ZHANG

Done at SAN JUAN CAPISTRANO on 11-30-2020
City, State CA Date David Tuck
David TUCK

Done at _____, on _____
City, State Date Bo ZHENG

Done at _____, on _____
City, State Date Yinghua YANG

Done at _____, on _____
City, State Date Han ZHANG

ASSIGNMENT

WHEREAS, WE,

1. Min WANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
2. Mangesh CHANSARKAR, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
3. Ning LUO, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
4. Gengsheng ZHANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
5. David TUCK, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
6. Bo ZHENG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
7. Yinghua YANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,
8. Han ZHANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **ULTRA-LONG BASELINE RTK** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have

been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/998,612 filed August 20, 2020, Qualcomm Reference Number 193476, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State Date Min WANG

Done at _____, on _____
City, State Date Mangesh CHANSARKAR

Done at _____, on _____
City, State Date Ning LUO

Done at _____, on _____
City, State Date Gengsheng ZHANG

Done at _____, on _____
City, State Date David TUCK

Done at Sunnyvale, CA, on 12/01/2020
City, State Date Bo ZHENG

Done at _____, on _____
City, State Date Yinghua YANG

Done at _____, on _____
City, State Date Han ZHANG

ASSIGNMENT

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7. Yinghua YANG, having a mailing address located at **5775 Morehouse Drive, San Diego, California 92121-1714,**
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **ULTRA-LONG BASELINE RTK** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/998,612 filed August 20, 2020, Qualcomm Reference Number 193476, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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Done at _____, on _____
City, State Date Min WANG

Done at _____, on _____
City, State Date Mangesh CHANSARKAR

Done at _____, on _____
City, State Date Ning LUO

Done at _____, on _____
City, State Date Gengsheng ZHANG

Done at _____, on _____
City, State Date David TUCK

Done at _____, on _____
City, State Date Bo ZHENG

Done at San Jose, CA, on 12/01/2020
City, State Date Yinghua Yang
Yinghua YANG

Done at _____, on _____
City, State Date Han ZHANG

ASSIGNMENT

WHEREAS, WE,

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City, State Date

Min WANG

Done at _____, on _____
City, State Date

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City, State Date

Ning LUO

Done at _____, on _____
City, State Date

Gengsheng ZHANG

Done at _____, on _____
City, State Date

David TUCK

Done at _____, on _____
City, State Date

Bo ZHENG

Done at _____, on _____
City, State Date

Yinghua YANG

Done at Santa Clara, CA, on 12/1/2020
City, State Date

Han Zhang
Han ZHANG